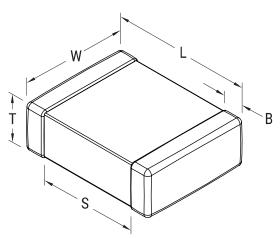




CAN SMD Indust 250, Ceramic, 0.056 uF, 5%, COG, SMD Chip, MLCC, AC Rated, 2225, 3.2 mm



Click	here	for	the	3D	model
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Dimensions	
Chip Size	2225
L	5.9mm +/-0.75mm
W	6.4mm +/-0.4mm
Т	1.4mm +/-0.15mm
S	3.2mm MIN
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

General Information	
Series	CAN SMD Indust 250
Style	SMD Chip
Description	SMD Chip, MLCC, AC Rated
Features	Temperature Stable, Class I
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	300 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.056 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage AC	250 VAC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms

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